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### EUROPEAN STANDARD NORME EUROPÉENNE EUROPÄISCHE NORM

### EN 60603-7

Supersedes EN 60603-7:1993

January 1997

ICS 31.220.10

Descriptors: Printed board connector, 8-way, ISDN

English version

### Connectors for frequencies below 3 MHz for use with printed boards Part 7: Detail specification for connectors, 8-way, including fixed and free connectors with common mating features, with assessed quality (IEC 603-7:1996)

Connecteurs pour fréquences inférieures à 3 MHz pour utilisation avec cartes imprimées Partie 7: Spécification particulière pour connecteurs à 8 voies, comprenant des embases et des fiches ayant des caractéristiques d'accouplement communes, avec assurance de la qualité (CEI 603-7:1996) Steckverbinder für Frequenzen unter 3 MHz für gedruckte Schaltungen Teil 7: Bauartspezifikation für Steckverbinder mit bewerteter Qualität, 8-polig, einschließlich fester und freier Steckverbinder mit gemeinsamen Steckmerkmalen (IEC 603-7:1996)

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# CENELEC

European Committee for Electrotechnical Standardization Comité Européen de Normalisation Electrotechnique Europäisches Komitee für Elektrotechnische Normung

Central Secretariat: rue de Stassart 35, B - 1050 Brussels

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#### Foreword

The text of document 48B/489/FDIS, future edition 2 of IEC 603-7, prepared by SC 48B, Connectors, of IEC TC 48, Electromechanical components and mechanical structures for electronic equipment, was submitted to the IEC-CENELEC parallel vote and was approved by CENELEC as EN 60603-7 on 1996-12-09.

This European Standard supersedes EN 60603-7:1993.

The following dates were fixed:

| <ul> <li>latest date by which the EN has to be implemented<br/>at national level by publication of an identical</li> </ul> |                  |
|----------------------------------------------------------------------------------------------------------------------------|------------------|
| national standard or by endorsement                                                                                        | (dop) 1997-09-01 |
| <ul> <li>latest date by which the national standards conflicting<br/>with the EN have to be withdrawn</li> </ul>           | (dow) 1997-09-01 |

Annexes designated "normative" are part of the body of the standard. In this standard, annexes A, B, C, D and ZA are normative. Annex ZA has been added by CENELEC.

Information from the foreword of the International Standard considered necessary:

The International Electrotechnical Commission (IEC) draws attention to the fact that it is claimed that compliance with this International Standard may involve the use of a patent concerning connectors, 8-way, for interconnect systems given in clauses 3 and 4.

The IEC takes no position concerning the evidence, validity and scope of this patent right.

The holder of this patent right has assured the IEC that he is willing to negotiate licences under reasonable and non-discriminatory terms and conditions with applicants throughout the world. In this respect, the statement of the holder of this patent right is registered with the IEC. Information may be obtained from:

AT&T Intellectual Property Licensing and Management Organization 10 Independence Boulevard P.O. Box 4911 Warren, New Jersey 07060-0911 United States of America

Attention is drawn to the possibility that some of the elements of this International Standard may be the subject of patent rights other than those identified above. IEC shall not be held responsible for identifying any or all such patent rights.

#### **Endorsement notice**

The text of the International Standard IEC 603-7:1996 was approved by CENELEC as a European Standard without any modification.

#### Annex ZA (normative)

## Normative references to international publications with their corresponding European publications

This European Standard incorporates by dated or undated reference, provisions from other publications. These normative references are cited at the appropriate places in the text and the publications are listed hereafter. For dated references, subsequent amendments to or revisions of any of these publications apply to this European Standard only when incorporated in it by amendment or revision. For undated references the latest edition of the publication referred to applies (including amendments).

NOTE: When an international publication has been modified by common modifications, indicated by (mod), the relevant EN/HD applies.

| Publication | <u>Year</u> | Title                                                                                                                                                                                                                                            | <u>EN/HD</u> | Year |
|-------------|-------------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|--------------|------|
| IEC 50(581) | 1978        | International Electrotechnical<br>Vocabulary (IEV)<br>Chapter 581: Electromechanical<br>components for electronic equipment                                                                                                                      | -            | -    |
| IEC 68-1    | 1988        | Environmental testing<br>Part 1: General and guidance                                                                                                                                                                                            | EN 60068-11) | 1994 |
| IEC 326-3   | 1991        | Printed boards<br>Part 3: Design and use of printed boards                                                                                                                                                                                       | -            | -    |
| IEC 352-2   | 1990        | Solderless connections<br>Part 2: Solderless crimped connections<br>General requirements, test methods and<br>practical guidance                                                                                                                 | EN 60352-2   | 1994 |
| IEC 352-3   | 1993        | Part 3: Solderless accessible insulation<br>displacement connections - General<br>requirements, test methods and practical<br>guidance                                                                                                           | EN 60352-3   | 1994 |
| IEC 352-4   | 1994        | Part 4: Solderless non-accessible insulation<br>displacement connections - General<br>requirements, test methods and practical<br>guidance                                                                                                       | EN 60352-4   | 1994 |
| IEC 410     | 1973        | Sampling plans and procedures for inspection by attributes                                                                                                                                                                                       | -            | -    |
| IEC 512-2   | 1985        | Electromechanical components for<br>electronic equipment - Basic testing<br>procedures and measuring methods<br>Part 2: General examination, electrical<br>continuity and contact resistance tests,<br>insulation tests and voltage stress tests | -            | -    |

<sup>1)</sup> EN 60068-1 includes the corrigendum October 1988 and A1:1992 to IEC 68-1.

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| Publication                                                            | <u>Year</u>                          | Title                                                                                                                                                                                                                                                                                                                                                                                                                                                      | EN/HD                           | <u>Year</u>  |
|------------------------------------------------------------------------|--------------------------------------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|---------------------------------|--------------|
| IEC 512-3                                                              | 1976                                 | Part 3: Current-carrying capacity tests                                                                                                                                                                                                                                                                                                                                                                                                                    | -                               | -            |
| IEC 512-4                                                              | 1976                                 | Part 4: Dynamic stress tests                                                                                                                                                                                                                                                                                                                                                                                                                               |                                 | -            |
| IEC 512-5                                                              | 1992                                 | Part 5: Impact tests (free components),<br>static load tests (fixed components),<br>endurance tests and overload tests                                                                                                                                                                                                                                                                                                                                     | -                               | -            |
| IEC 512-6                                                              | 1984                                 | Part 6: Climatic tests and soldering tests                                                                                                                                                                                                                                                                                                                                                                                                                 | -                               | -            |
| IEC 512-7                                                              | 1988                                 | Part 7: Mechanical operating tests and sealing tests                                                                                                                                                                                                                                                                                                                                                                                                       | -                               | -            |
| IEC 512-8                                                              | 1993                                 | Part 8: Connector tests (mechanical) and mechanical tests on contacts and terminations                                                                                                                                                                                                                                                                                                                                                                     | -                               | -            |
| IEC 603-1                                                              | 1991                                 | Connectors for frequencies below 3 MHz<br>for use with printed boards<br>Part 1: Generic specification - General<br>requirements and guide for the preparation<br>of detail specifications, with assessed<br>quality                                                                                                                                                                                                                                       | -                               | -            |
| A1                                                                     | 1992                                 | quanty                                                                                                                                                                                                                                                                                                                                                                                                                                                     | -                               | -            |
|                                                                        |                                      |                                                                                                                                                                                                                                                                                                                                                                                                                                                            |                                 |              |
| IEC 664-1<br>(mod)                                                     | 1992                                 | Insulation coordination for equipment within<br>low-voltage systems<br>Part 1: Principles, requirements and tests                                                                                                                                                                                                                                                                                                                                          | HD 625.1 S1<br>+ corr. November | 1996<br>1996 |
|                                                                        | 1992<br>1991                         | low-voltage systems                                                                                                                                                                                                                                                                                                                                                                                                                                        |                                 |              |
| (mod)<br>IEC 807-1<br>IEC QC                                           |                                      | low-voltage systems<br>Part 1: Principles, requirements and tests<br>Rectangular connectors for frequencies<br>below 3 MHz<br>Part 1: Generic specification<br>General requirements and guide for the<br>preparation of detail specifications for<br>connectors with assessed quality<br>Basic rules of the IEC Quality Assessment                                                                                                                         |                                 |              |
| (mod)<br>IEC 807-1                                                     | 1991                                 | low-voltage systems<br>Part 1: Principles, requirements and tests<br>Rectangular connectors for frequencies<br>below 3 MHz<br>Part 1: Generic specification<br>General requirements and guide for the<br>preparation of detail specifications for<br>connectors with assessed guality                                                                                                                                                                      |                                 |              |
| (mod)<br>IEC 807-1<br>IEC QC<br>001001<br>A2                           | 1991<br>1986<br>1994                 | low-voltage systems<br>Part 1: Principles, requirements and tests<br>Rectangular connectors for frequencies<br>below 3 MHz<br>Part 1: Generic specification<br>General requirements and guide for the<br>preparation of detail specifications for<br>connectors with assessed quality<br>Basic rules of the IEC Quality Assessment<br>System for Electronic Components (IECQ)<br>Rules of procedure of the IEC Quality<br>Assessment System for Electronic |                                 |              |
| (mod)<br>IEC 807-1<br>IEC QC<br>001001<br>A2<br>A3<br>IEC QC           | 1991<br>1986<br>1994<br>1995         | low-voltage systems<br>Part 1: Principles, requirements and tests<br>Rectangular connectors for frequencies<br>below 3 MHz<br>Part 1: Generic specification<br>General requirements and guide for the<br>preparation of detail specifications for<br>connectors with assessed quality<br>Basic rules of the IEC Quality Assessment<br>System for Electronic Components (IECQ)<br>Rules of procedure of the IEC Quality                                     |                                 |              |
| (mod)<br>IEC 807-1<br>IEC QC<br>001001<br>A2<br>A3<br>IEC QC<br>001002 | 1991<br>1986<br>1994<br>1995<br>1986 | low-voltage systems<br>Part 1: Principles, requirements and tests<br>Rectangular connectors for frequencies<br>below 3 MHz<br>Part 1: Generic specification<br>General requirements and guide for the<br>preparation of detail specifications for<br>connectors with assessed quality<br>Basic rules of the IEC Quality Assessment<br>System for Electronic Components (IECQ)<br>Rules of procedure of the IEC Quality<br>Assessment System for Electronic |                                 |              |



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